

DATASHEET

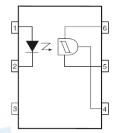
6 PIN DIP SCHMITT TRIGGER PHOTOCOUPLER H11LX Series



Features:

- High data rate, 1MHz typical (NRZ)
- Free from latch up and oscillation throughout voltage and temperature ranges.
- · Microprocessor compatible drive
- Logic compatible output sinks 16mA at 0.4V maximum
- Guaranteed on/off threshold hysteresis
- Wide supply voltage capability, compatible with all popular logic systems
- High isolation voltage between input and output (Viso=5000 V rms)
- Compact dual-in-line package
- •The product itself will remain within RoHS compliant version
- •Compliance with EU REACH
- UL and cUL approved(No. E214129)
- VDE approved (No. 132249)
- SEMKO approved
- NEMKO approved
- DEMKO approved
- FIMKO approved
- CQC approved

Schematic



Pin Configuration

- 1. Anode
- 2. Cathode
- 3. No Connection
- 4. Vo
- 5. GND
- 6. V_{CC}

Truth Table

Input	Output
Н	L
L	Н

Description

The H11LX series of devices each consist of a GaAs infrared emitting diode optically coupled a high speed integrated circuit detector. The output detector incorporates a Schmitt trigger, which provides hysteresis for noise immunity and pulse shaping.

The devices are in a 6-pin DIP package and available in wide-lead spacing and SMD option.

Applications

- Logic to logic isolator
- Programmable current level sensor
- Line receiver eliminate noise and transient problems
- AC to TTL conversion square wave shaping
- Digital programming of power supplies
- Interfaces computers with peripherals



Absolute Maximum Ratings (Ta=25°C)

	Parameter	Symbol	Rating	Unit
Input	Forward current	l _F	60	mA
	Reverse voltage	V_{R}	6	V
	Power dissipation	P_{D}	120	mW
Output	V ₄₅ Allowed Range	Vo	0 to 16	V
	V ₆₅ Allowed Range	Vcc	3 to 16	V
	Output Current	lo	50	mA
	Power dissipation	P _D	150	mW
Total powe	r dissipation	P _{tot}	250	mW
Isolation vo	oltage	V _{iso}	5000	V rms
Operating temperature		T _{opr}	-55~+100	°C
Storage temperature		T _{stg}	-55~+125	°C
Soldering temperature *2		T _{sol}	260	°C

Notes:

^{*1} AC for 1 minute, R.H.= $40 \sim 60\%$ R.H. In this test, pins 1, 2 & 3 are shorted together, and pins 4, 5 & 6 are shorted together.

^{*2} For 10 seconds



Electro-Optical Characteristics (Ta=25°C unless specified otherwise)

Input

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Forward Voltage	V _F	-	1.15	1.5	V	$I_F = 10mA$
Reverse Current	I _R	-	-	10	μA	V _R = 5V
Input capacitance	CJ	-	-	100	pF	V=0, f=1MHz

Output

Parameter	Symbol	Min.	Тур.*	Max.	Unit	Condition
Operation Voltage Range	Vcc	3	-	15	V	
Supply Current	$I_{CC(off)}$	-	1.6	5	mA	I _F =0mA, Vcc=5V
Output Current, High	I _{OH}	-	-	100	μΑ	I _F =0mA, Vcc=Vo=15V
Isolation Resistance	R _{ISO}	10 ¹¹	-	-	Ω	V _{I-O} =500VDC

Transfer Characteristics

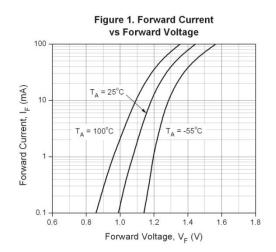
Parameter	Symbol	Min	Тур.	Max.	Unit	Condition	
Supply Current	I _{CC(on)}	-	1.6	5	mA	I _F =10mA, Vcc=5V	
Output Voltage .low	V_{OL}			0.4	V	Vcc=5V, $I_F=I_{Fon}(max.)$, $R_L=270\Omega$	
Turn on H11L1		- 1	-	1.6	_		
Threshold H11L2	I _{Fon}	-	-	10	mA	Vcc=5V, R_L =270 Ω	
Current ¹ H11L3		-	-	5			
Turn off Threshold Current	I _{Foff}	-	1	-	mA	Vcc=5V, R _L =270Ω	
Hysteresis Ratio	I _{Foff} /I _{Fon}	0.5	-	0.9		Vcc=5V, R_L =270 Ω	
Turn on Time	t _{on}	-	-	4	μS		
Fall Time	t _r	-	0.1	-	μS	$Vcc=5V$, $I_{F}=I_{Fon}$,	
Turn off Time	t _{off}	-	-	4	μS	$R_{L}=270\Omega$	
Rise Time	t _r	-	0.1	-	μS		
Data Rate		-	1	-	MHz		

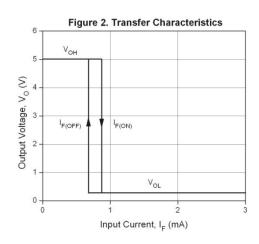
^{*} Typical values at T_a = 25°C

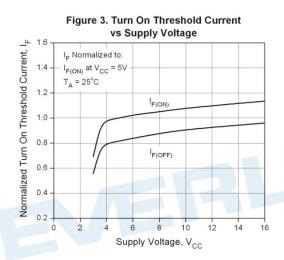
¹. Max. I_{F(ON)} is the maximum current required to trigger the output. For examples, a 1.6mA maximum trigger current would require the LED to be driven at a current greater than 1.6mA to guarantee the device will turn on. A 10% guard band is recommended to account for degradation of the LED over its lifetime. The maximum allowable LED drive current is 60mA.

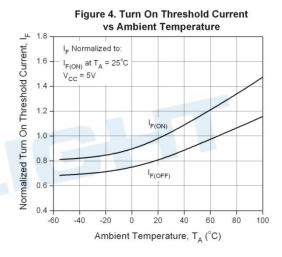


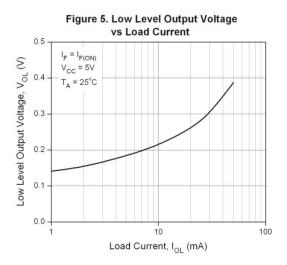
Typical Electro-Optical Characteristics Curves

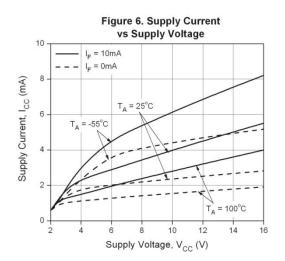












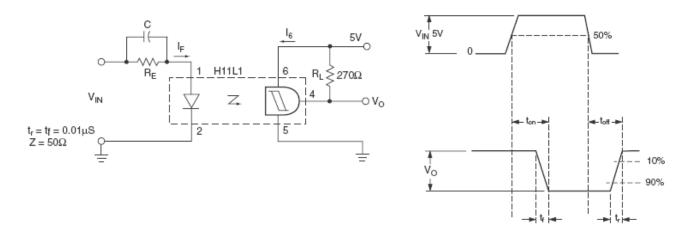


Figure 7. Switching Time Test Circuit & Waveforms

Order Information

Part Number

H11LXY(Z)-V

Note

 \overline{X} = Part No. for 1, 2 or 3

Y = Lead form option (S, S1, M or none)Z = Tape and reel option (TA, TB or none).

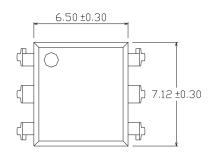
V = VDE (optional)

Option	Description	Packing quantity
None	Standard DIP-6	65 units per tube
М	Wide lead bend (0.4 inch spacing)	65 units per tube
S + TA	Surface mount lead form + TA tape & reel option	1000 units per reel
S + TB	Surface mount lead form + TB tape & reel option	1000 units per reel
S1 + TA	Surface mount lead form (low profile) + TA tape & reel option	1000 units per reel
S1 + TB	Surface mount lead form (low profile) + TB tape & reel option	1000 units per reel

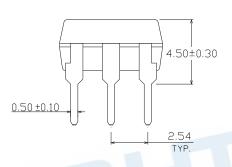


Package Dimension (Dimensions in mm)

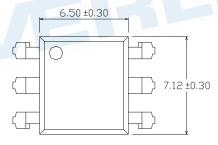
Standard DIP Type

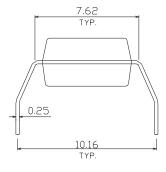


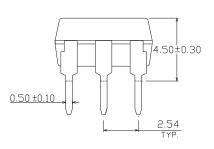




Option M Type

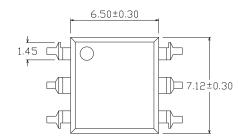


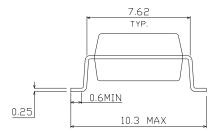


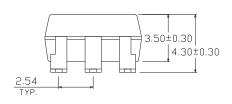




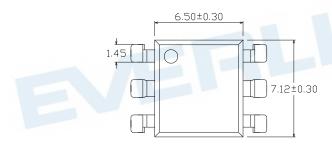
Option S Type

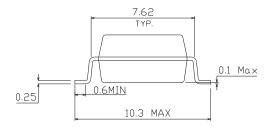


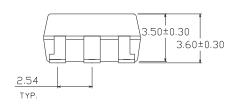




Option S1 Type

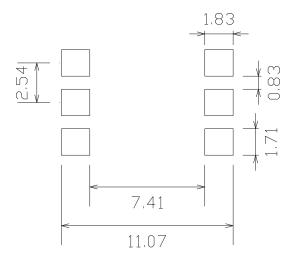








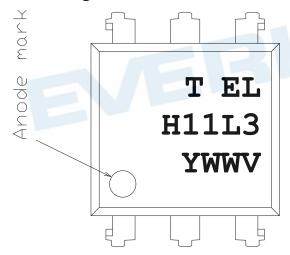
Recommended pad layout for surface mount leadform



Notes

Suggested pad dimension is just for reference only. Please modify the pad dimension based on individual need.

Device Marking



T denotes Factory

No code : made in China

T: made in Taiwan

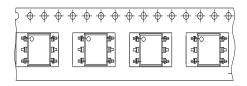
EL denotes Everlight

H11L3 denotes Device Number
Y denotes 1 digit Year code
WW denotes 2 digit Week code
V denotes VDE (optional)



Tape & Reel Packing Specifications

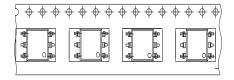
Option TA



Direction of feed from reel



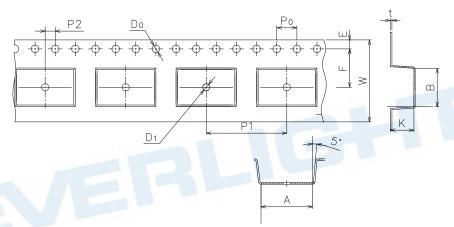
Option TB



Direction of feed from reel



Tape dimensions



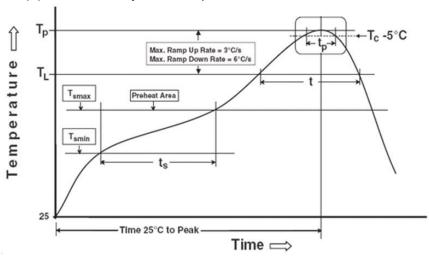
Dimension No.	Α	В	Do	D1	E	F
Dimension(mm)	10.8±0.1	7.55±0.1	1.5±0.1	1.5+0.1/-0	1.75±0.1	7.5±0.1
Dimension No.	Ро	P1	P2	t	w	К
Dimension(mm)	4.0±0.15	12±0.1	2.0±0.1	0.35±0.03	16.0±0.2	4.5±0.1



Precautions for Use

1. Soldering Condition

1.1 (A) Maximum Body Case Temperature Profile for evaluation of Reflow Profile



Note:

Preheat

Temperature min (T_{smin})

Temperature max (T_{smax})

Time (T_{smin} to T_{smax}) (t_s)

Average ramp-up rate (T_{smax} to T_p)

Other

Liquidus Temperature (T_L)

Time above Liquidus Temperature (t L)

Peak Temperature (T_P)

Time within 5 °C of Actual Peak Temperature: TP - 5°C

Ramp- Down Rate from Peak Temperature

Time 25°C to peak temperature

Reflow times

Reference: IPC/JEDEC J-STD-020D

150 °C

200°C

60-120 seconds

3 °C/second max

217 °C

60-100 sec

260°C

30 s

6°C /second max.

8 minutes max.

3 times



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